

FINAL VERSION

VERSION FINALE



**Electromechanical elementary relays –
Part 1: General and safety requirements**

**Relais électromécaniques élémentaires –
Partie 1: Exigences générales et de sécurité**

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

ELECTROMECHANICAL ELEMENTARY RELAYS –

Part 1: General and safety requirements

FOREWORD

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This consolidated version of IEC 61810-1 bears the edition number 4.1. It consists of the fourth edition (2015-02) [documents 94/380/FDIS and 94/384RVD], its corrigenda 1 (2017-06) and 2 (2018-02), and its amendment 1 (2012-02) [documents 94/450/CDV and 94/460/RVC]. The technical content is identical to the base edition and its amendment.

This Final version does not show where the technical content is modified by amendment 1. A separate Redline version with all changes highlighted is available in this publication.

International Standard IEC 61810-1 has been prepared by IEC technical committee 94: All-or-nothing electrical relays.

This fourth edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- two main test procedures were introduced: procedure A, reflecting the procedure known from Edition 3 of this standard and procedure B, reflecting the assessment according to North American requirements;
- inclusion of dedicated device application tests especially relevant for applications in the North American Market (see Clause D.1);
- introduction of testing under single mounting condition;
- clarification of insulation requirements after endurance testing;
- inclusion of provisions for basic safety requirements;
- update of references.

This publication has been drafted in accordance with the ISO/IEC Directives Part 2.

A list of all parts of IEC 61810 series, published under the general title *Electromechanical elementary relays* can be found on the IEC website.

The committee has decided that the contents of the base publication and its amendment will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colour which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

ELECTROMECHANICAL ELEMENTARY RELAYS –

Part 1: General and safety requirements

1 Scope

This part of IEC 61810 applies to electromechanical elementary relays (non-specified time all-or-nothing relays) for incorporation into low voltage equipment (circuits up to 1 000 V alternate current or 1 500 V direct current). It defines the basic functional and safety requirements and safety-related aspects for applications in all areas of electrical engineering or electronics, such as:

- general industrial equipment,
- electrical facilities,
- electrical machines,
- electrical appliances for household and similar use,
- information technology and business equipment,
- building automation equipment,
- automation equipment,
- electrical installation equipment,
- medical equipment,
- control equipment,
- telecommunications,
- vehicles,
- transportation (e.g. railways).

Compliance with the requirements of this standard is verified by the type tests indicated.

In case the application of a relay determines additional requirements exceeding those specified in this standard, the relay should be assessed in line with this application in accordance with the relevant IEC standard(s) (e.g. IEC 60730-1, IEC 60335-1, IEC 60950-1).

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60038:2009, *IEC standard voltages*

IEC 60050 (all parts), *International Electrotechnical Vocabulary* (available at <http://www.electropedia.org>)

IEC 60068-2-2:2007, *Environmental testing – Part 2-2: Tests – Test B: Dry heat*

IEC 60068-2-17:1994, *Basic environmental testing procedures – Part 2-17: Tests – Test Q: Sealing*